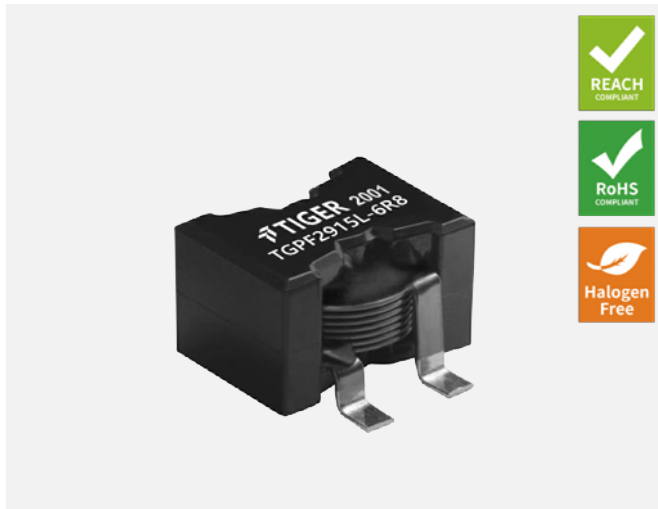




Outline:

- Third mounting pad for greater stability and board adhesion
- High inductance, high current, low magnetic loss, low ESR, small parasitic capacitance.
- Flat wire winding, achieve a low D.C. Resistance.
- Temperature rise current and saturation current is less influenced by environment.

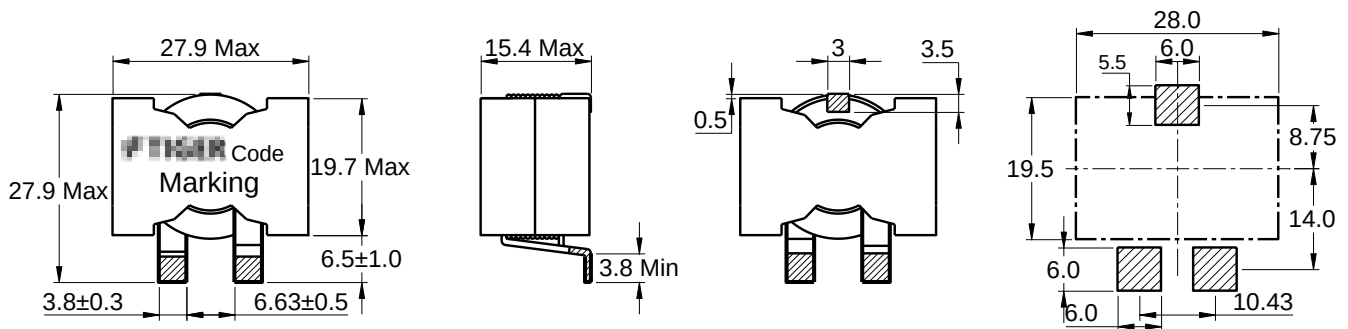
Features:

- Core material: Ferrite
- Environmental: RoHS, Reach compliant, Halogen free
- Weight: 32.5 g
- Moisture Sensitivity: Level (MSL) 1
(unlimited floor life at <30° C /85% relative humidity)
- Operating temperature range: -40°C~+125°C
(including coil's self temperature rise).
- Storage temperature range: -40°C~+125°C

Application:

- Ideally used in tablet PC, LCD display, server application.
- high current power supplies, Battery power devices
- DC/DC converters in distributed power systems

1 Product Dimensions (mm)



Typical Pad Layout

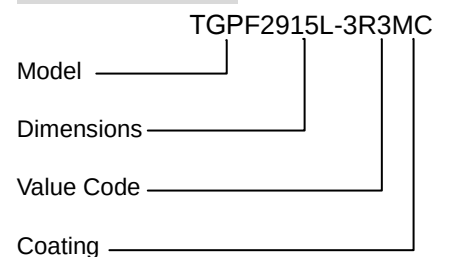
2 Electrical Characteristics

Part No.	Inductance (μH)※1 ±20%	D.C.R. (mΩ)		Isat (A)※2 Typical	Irms (A) ※3 Typical
		Typical	Max		
TGPF2915L-1R5MC	1.50	1.20	1.36	>100	34.0
TGPF2915L-2R2MC	2.20	1.20	1.36	84.8	34.0
TGPF2915L-3R3MC	3.30	1.20	1.36	57.0	34.0
TGPF2915L-4R7MC	4.70	1.20	1.36	39.0	34.0
TGPF2915L-6R8MC	6.80	1.20	1.36	27.8	34.0
TGPF2915L-100MC	10.0	1.20	1.36	17.6	34.0
TGPF2915L-150MC	15.0	1.20	1.36	11.0	34.0
TGPF2915L-220MC	22.0	1.20	1.36	6.80	34.0
TGPF2915L-330MC	33.0	1.20	1.36	3.30	34.0

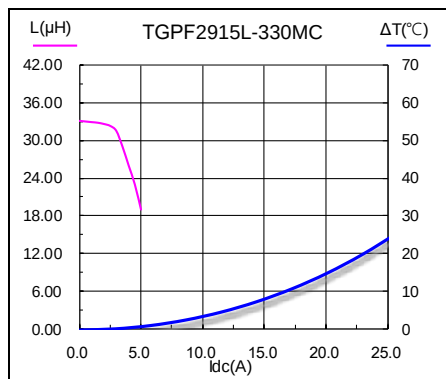
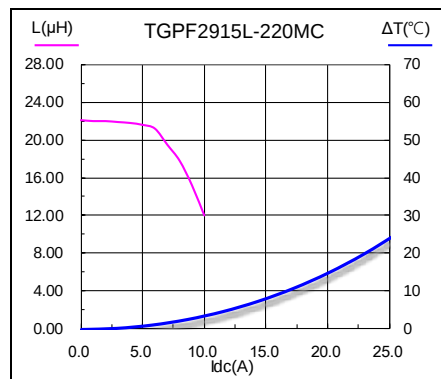
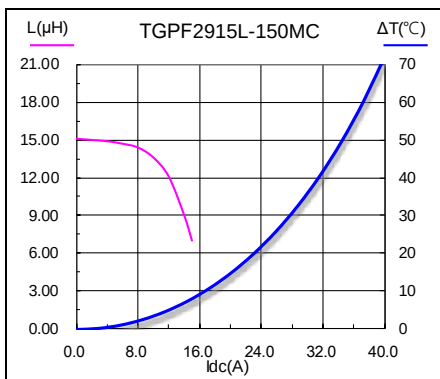
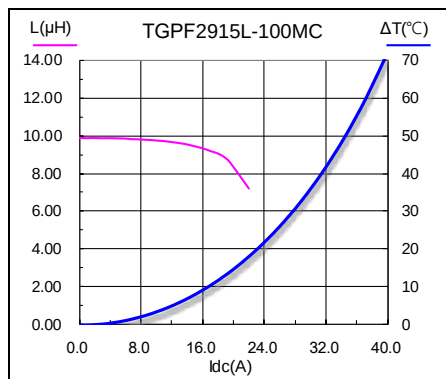
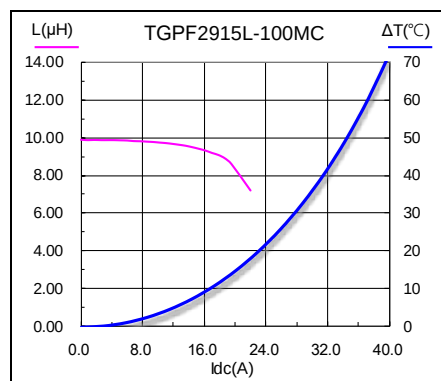
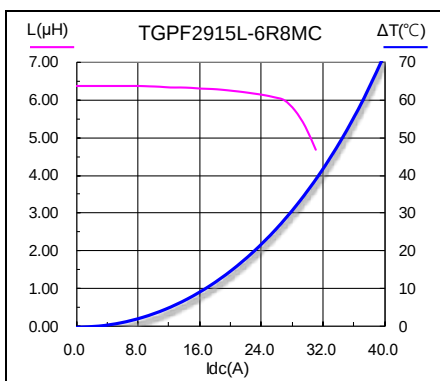
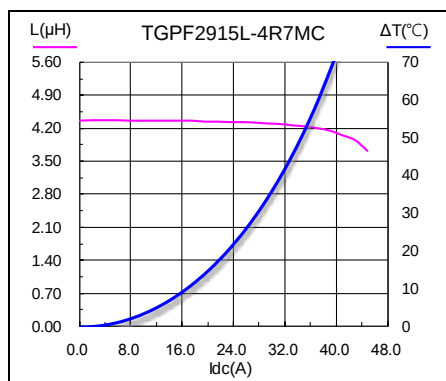
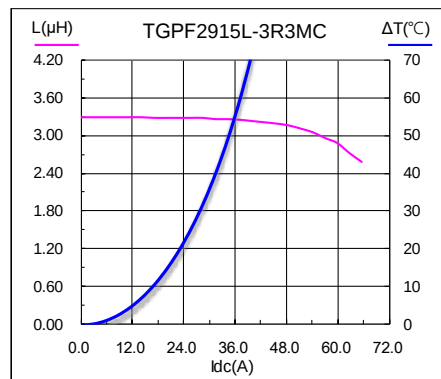
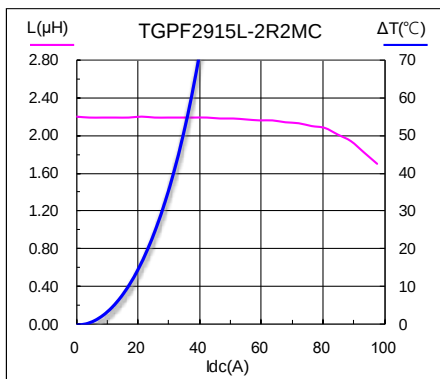
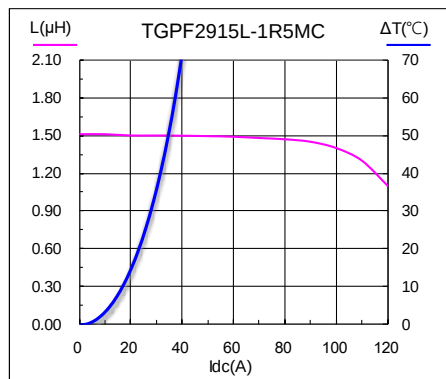
All data is tested on 25°C ambient temperature

- Inductance measure condition at 100kHz, 0.1V
- Isat: the actual value of DC current when the Inductance decrease 30% of its initial Value
- Irms: The actual value of DC current when the Temperature rise is ΔT40°C (Ta=25°C)

3 How to Order:

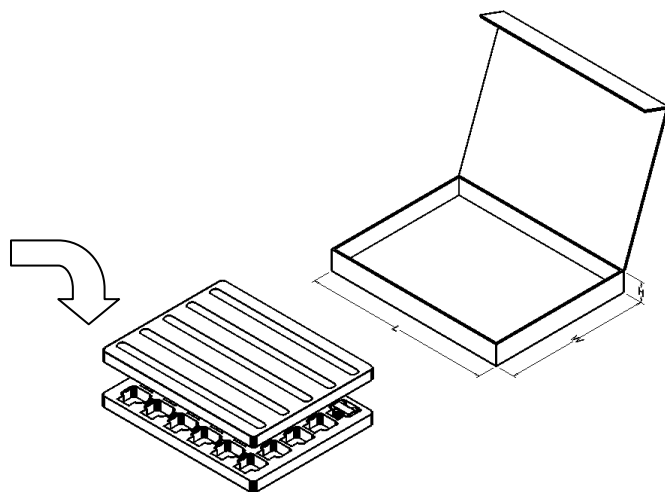
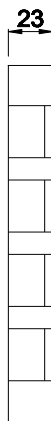
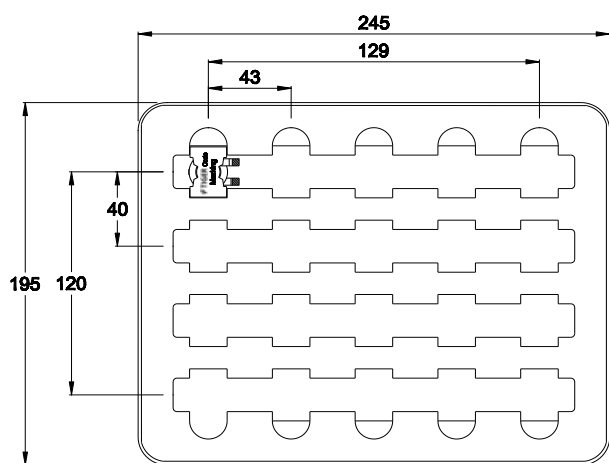


4 Saturation Current vs Temperature Rise Current Curve



5 Packing Specification

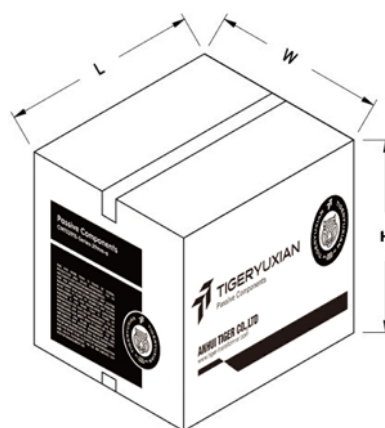
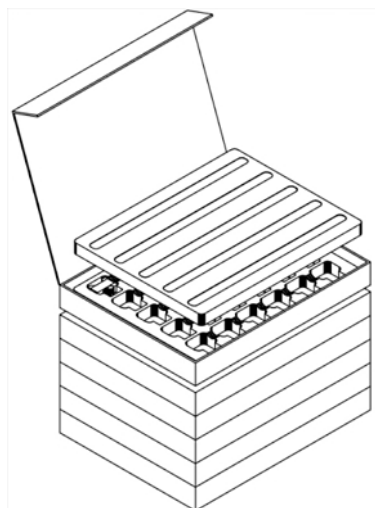
5.1 Plastic Tray Dimensions (mm)



Packaging Unit (Pcs)	Material
20	APET

L typ	W typ	H typ	No. of Tray (Pcs)	Packaging Unit(Pcs)	Material
265	205	30	1	20	Paper

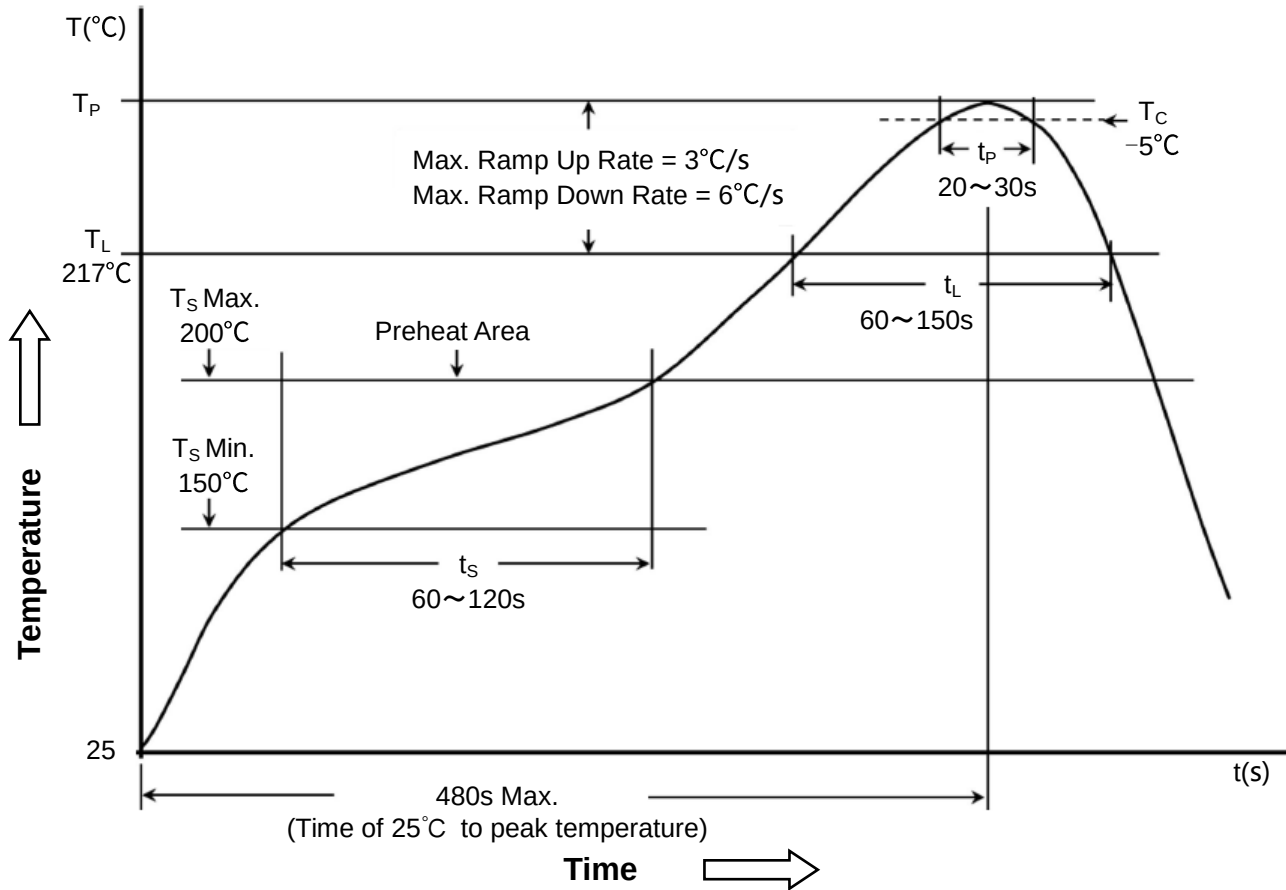
5.2 Packing(mm)



L typ	W typ	H typ	No. of Inner Carton	Packaging Unit(Pcs)	Material
275	232	255	8	160	Paper

6 Soldering Specification

6.1 Reflow Profile for SMT Components



6.2 Classification of Peak Package Body Temperature (T_P)

	Package Thickness	Package Volume		
		<350 mm ³	350~2000 mm ³	>2000 mm ³
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6~2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

※ Reflow is referred to standard IPC/JEDEC J-STD-020D.

7 Notice of Use

- 7.1 Special remind:Circuit design, component placement, PCB size and thickness, cooling system and etc. all will affect the product temperature. Please verify the product temperature in the final application.
- 7.2 Product in packing storage condition:temperature 5~40°C, RH≤70%.
If taking out for use, the remaining products should be sealed in plastic bags and preserved in accordance with the above conditions, to avoid oxidation of terminals (electrodes), affecting soldering status.
- 7.3 A storage of Codaca Electronic products for longer than 12 months is not recommended, Within other effects, the terminals may suffer degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of shipment.
- 7.4 Do not keep products in unsuitable storage conditions, such as areas susceptible to high temperatures, high humidity, dust or corrosion.
- 7.5 Always handle products with care.
- 7.6 Don't touch electrodes directly with bare hands as oil secretions may inhibit soldering.
Always ensure optimum conditions for soldering.
- 7.7 When this product will be used on a similar or new project to the original one,
sometimes it might be unable to satisfy the specifications due to different condition of usage.
- 7.8 This inductor itself does not have any protective function in abnormal condition, such as overload, short-circuit, open-circuit conditions, etc. Therefore, it shall be confirmed that there is no risk of smoke, fire, dielectric withstand voltage, insulation resistance, etc., or use in abnormal conditions protective devices or protection circuit in the end product.
- 7.9 Hi-Pot test with higher voltage than spec value will damage insulating material and shorten its life.
- 7.10 If using in potting compound, the magnet wire coating might be damaged, please consult with us.
- 7.11 Refrain from rinsing coils. If necessary, please consult with us.